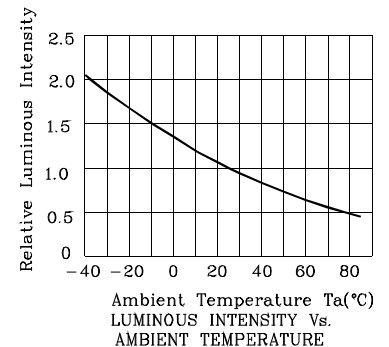
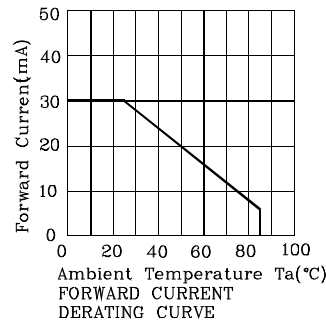
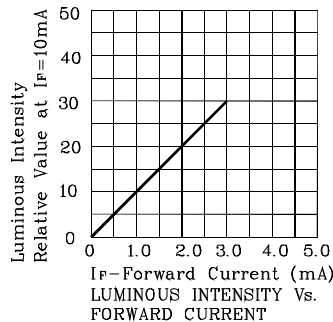
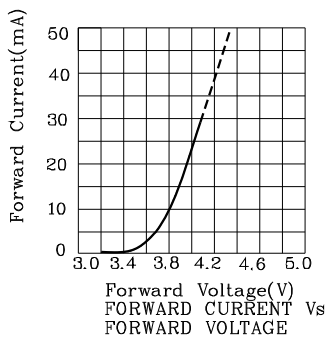




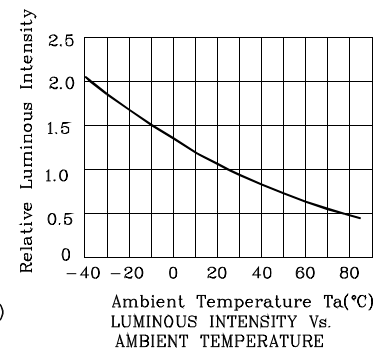
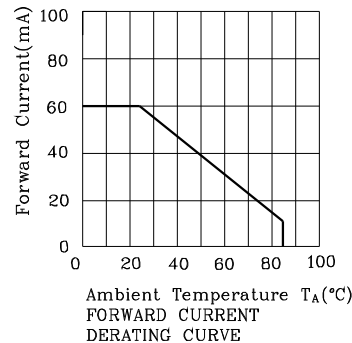
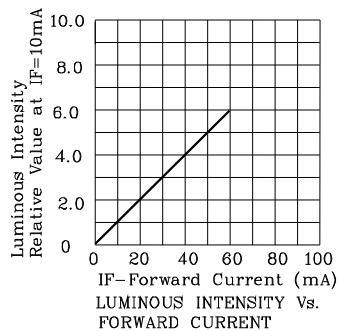
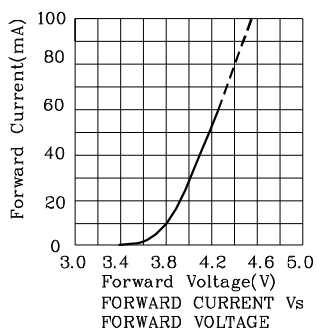
Absolute maximum ratings (TA=25°C)			UR (GaAsP/GaP)	Unit
Reverse Voltage	A1,A2,D1, D2,P,K	VR	5	V
	B,C,E,F,G, H,J,L,M,N		5	
	DP		5	
Forward Current	A1,A2,D1, D2,P,K	IF	30	mA
	B,C,E,F,G, H,J,L,M,N		60	
	DP		30	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	A1,A2,D1, D2,P,K	iFS	160	mA
	B,C,E,F,G, H,J,L,M,N		320	
	DP		160	
Power Dissipation	A1,A2,D1, D2,P,K	PD	150	mW
	B,C,E,F,G, H,J,L,M,N		300	
	DP		75	
Operating Temperature		TA	-40 ~ +85	°C
Storage Temperature		Tstg	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]		260°C For 3~5 Seconds		

Operating Characteristics (TA=25°C)			UR (GaAsP/GaP)	Unit
Forward Voltage (Typ.) (IF=10mA)	A1,A2,D1,D2, P,K	VF	3.8	V
	B,C,E,F,G,H, J,L,M,N		1.9	
	DP		1.9	
Forward Voltage (Max.) (IF=10mA)	A1,A2,D1,D2, P,K	VF	5	V
	B,C,E,F,G,H, J,L,M,N		2.5	
	DP		2.5	
Reverse Current (Max.) (VR=5V)	A1,A2,D1,D2, P,K	IR	10	uA
Reverse Current (Max.) (VR=5V)	B,C,E,F,G,H, J,L,M,N		20	
Reverse Current (Max.) (VR=5V)	DP		10	
Wavelength of Peak Emission (Typ.) (IF=10mA)		λP	627	nm
Wavelength of Dominant Emission (Typ.) (IF=10mA)		λD	625	nm
Spectral Line Full Width At Half- Maximum (Typ.) (IF=10mA)		Δλ	45	nm
Capacitance (Typ.) (VF=0V, f=1MHz)		C	15	pF

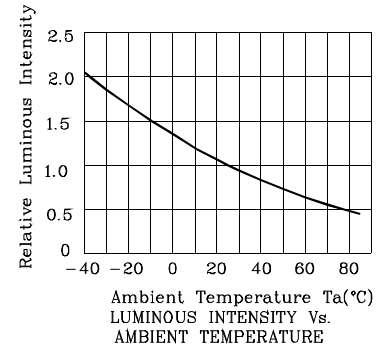
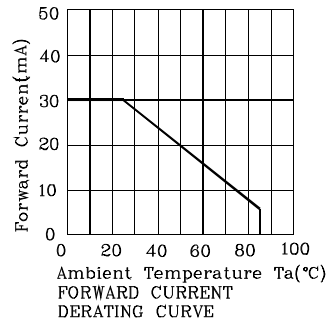
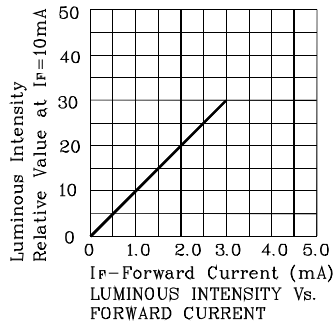
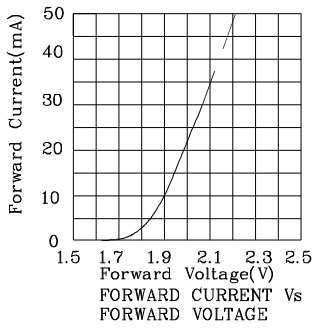
❖ UR



Note:the curves are on the segment a1,a2,d1,d2,p,k.

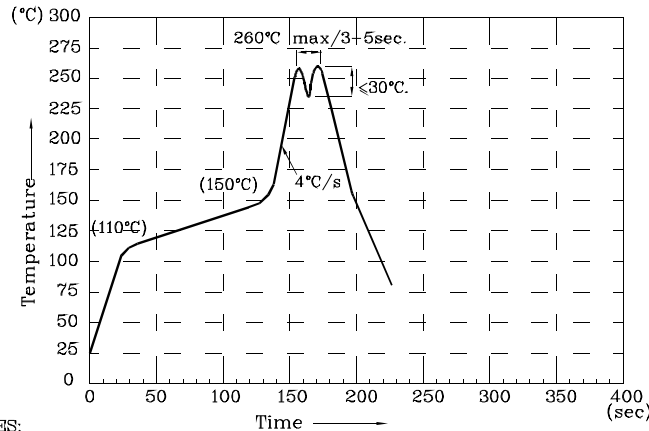


Note:the curves are on the segment b,c,e,f,g,h,j,l,m,n.



Note:the curves are on the DP.

### Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.During wave soldering, the PCB top-surface temperature should be kept below 105°C.
- 5.No more than once.

Remarks:

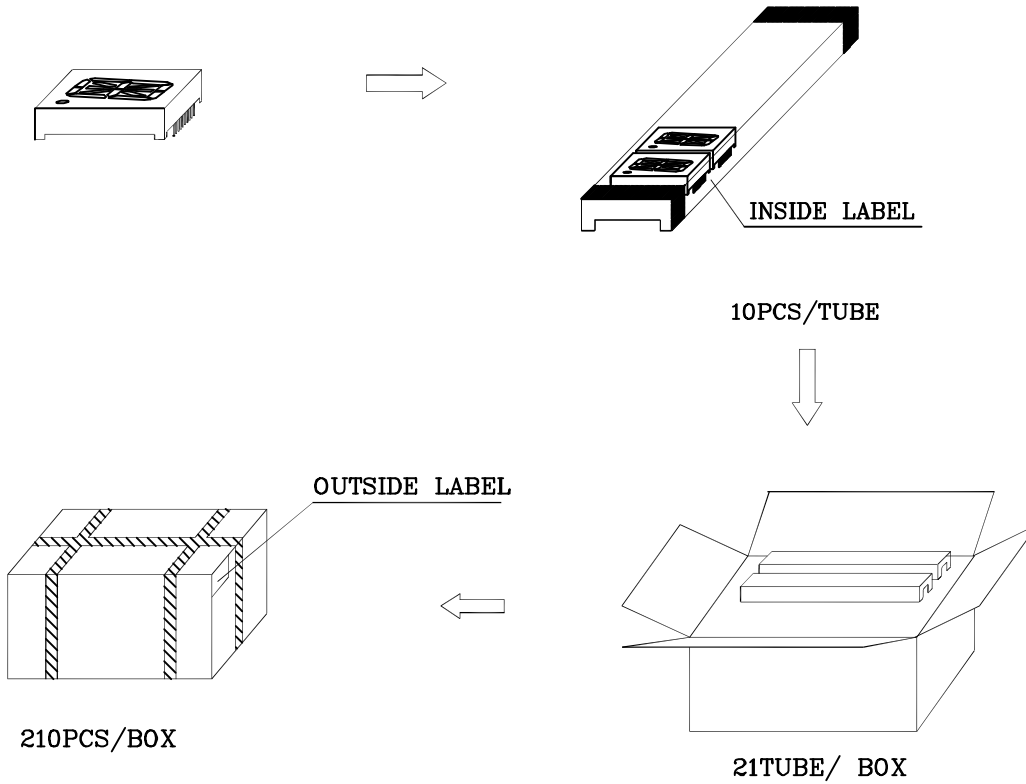
If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity / Luminous Flux: +/-15%
3. Forward Voltage: +/-0.1V

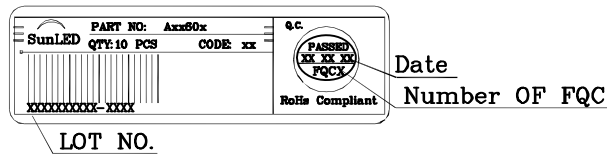
Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



Inside Label On IC-tube



Outside Label On Box

